

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	6198	((438/107) or (438/118) or (438/121) or (438/455) or (438/459) or (438/975) or (438/977)).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/04/29 17:40
L2	993	1 and (metal near5 substrate)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/29 17:40
L3	597	2 and (bond\$3 near5 substrate)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/29 17:41
L4	105	2 and (bond\$3 near5 (compound or III or Ga or As) near5 substrate)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/29 17:53
L5	2	4 and ((via or contact) near5 through near5 (compound or Ga or As))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/29 17:49
L6	4	4 and ((hole or opening) near5 through near5 (compound or Ga or As))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/29 17:49
L7	1	2 and (bond\$3 near5 (heterostructure) near5 substrate)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/29 17:55
L8	10	2 and (bond\$3 near5 (compound) near5 substrate)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/29 17:56

S1	372625	("438"/\$.ccls. or "257"/\$.ccls.)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/29 17:11
S2	42482	S1 and (metal near5 (substrate or wafer))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/11/29 12:44
S3	79	S2 and (bond\$3 same tile)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/11/29 12:45
S4	11	S3 and eutectic	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/11/29 12:45
S5	7	S4 and array\$2	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/11/29 12:45